WeEn WeEn

WNSC10650W

Silicon Carbide Diode

Rev.01 - 12 November 2020

Product data sheet

1. General description

Silicon Carbide Schottky diode in a TO247-2L plastic package, designed for high frequency switched-mode power supplies.



2. Features and benefits

- Highly stable switching performance
- High forward surge capability I_{FSM}
- Extremely fast reverse recovery time
- Superior in efficiency to Silicon Diode alternatives
- Reduced losses in associated MOSFET
- Reduced EMI
- Reduced cooling requirements
- RoHS compliant

3. Applications

- Power factor correction
- Telecom / Server SMPS
- UPS
- PV inverter
- PC Silverbox
- LED / OLED TV
- Motor Drives

4. Quick reference data

able 1. Q	uick reference data						
Symbol	Parameter	Conditions	Values			Unit	
Absolute	maximum rating						
V_{RRM}	repetitive peak reverse voltage			650		V	
$I_{F(AV)}$	average forward current	δ = 0.5 ; square-wave pulse; T _{mb} ≤ 119 °C; Fig. 1; Fig. 2; Fig. 3		10		A	
Tj	junction temperature			175		°C	
Symbol	Parameter	Conditions		Min Typ Max		Unit	
Static ch	aracteristics						
V _F	forward voltage	I _F = 10 A; T _j = 25 °C; <u>Fig. 5</u>		-	1.5	1.7	V
		I _F = 10 A; T _j = 150 °C; <u>Fig. 5</u>		-	1.68	2	V
Dynamic	characteristics						
Q _r	recovered charge	$I_F = 10 \text{ A}; \text{ d}I_F/\text{d}t = 500 \text{ A}/\mu\text{s}; \text{ V}_R = 400 \text{ V};$ $T_j = 25 ^\circ\text{C}; \text{ Fig. 7}$		-	16	-	nC

5. Pinning information

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	К	cathode		
2	А	anode		K — A 001aaa020
mb	mb	mounting base; connected to cathode	K A TO247-2L	

6. Ordering information

Table 3. Ordering information								
Type number	Package name	Orderable part number	Packing method	Small packing quantity	Package version	Package issue date		
WNSC10650W	TO247-2L	WNSC10650WQ	Tube	30	TO247L-2L	10-Nov-2020		

7. Marking

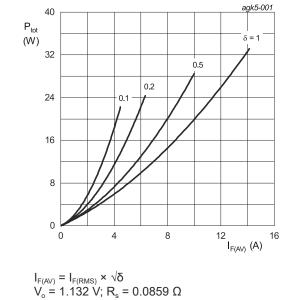
Table 4. Marking codes					
Type number	Marking codes				
WNSC10650W	WNSC 10650W				

8. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Values	Unit
V_{RRM}	repetitive peak reverse voltage		650	V
V _{RWM}	crest working reverse voltage		650	V
V _R	reverse voltage	DC	650	V
$\boldsymbol{I}_{F(AV)}$	average forward current	δ = 0.5; square-wave pulse; T _{mb} ≤ 119 °C; Fig. 1; Fig. 2; Fig. 3	10	A
I _{FRM}	repetitive peak forward current	δ = 0.5; t _p = 25 μs; T _{mb} ≤ 119 °C; square-wave pulse	20	A
I _{FSM}	non-repetitive peak	t_p = 10 ms; $T_{j(init)}$ = 25 °C; sine-wave pulse	50	А
	forward current	t_p = 10 µs; $T_{j(init)}$ = 25 °C; square-wave pulse	450	А
l ² t	I ² t for fusing	sine-wave pulse; $T_{j(init)}$ = 25 °C; t_p = 10 ms	12.5	A ² s
T _{stg}	storage temperature		-55 to 175	°C
T _j	junction temperature		175	°C



V_o⁻ = 1.132 V; R_s = 0.0859 Ω
Fig. 1. Forward power dissipation as a function of average forward current; square waveform; maximum values

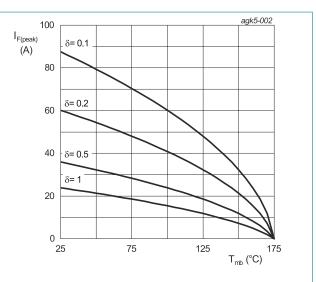
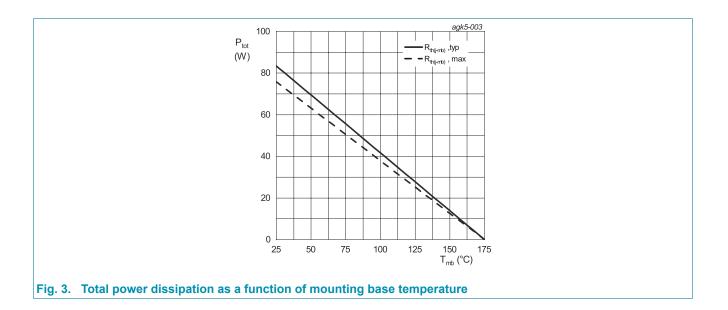


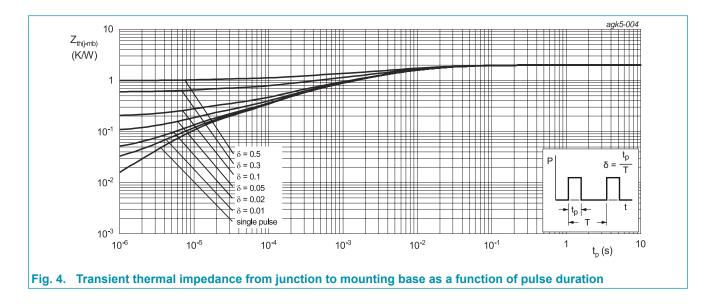
Fig. 2. Current derating as a function of mounting base temperature

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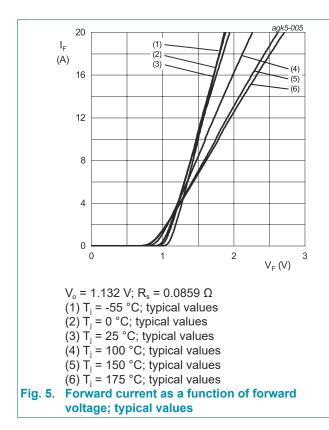
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$R_{\text{th(j-mb)}}$	thermal resistance from junction to mounting base	<u>Fig. 4</u>	-	1.8	1.98	K/W
$R_{\text{th(j-a)}}$	thermal resistance from junction to ambient free air	in free air	-	40	-	K/W

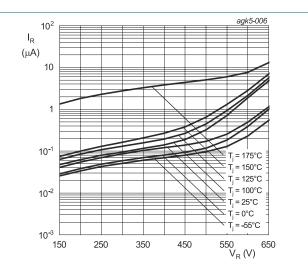
9. Thermal characteristics



10. Characteristics

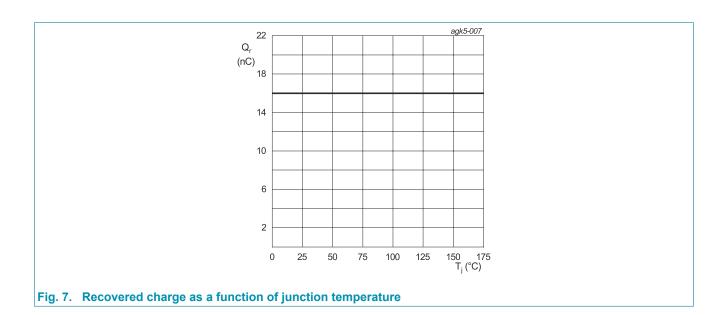
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Static cha	racteristics					
V _F	forward current	I _F = 10 A; T _j = 25 °C; <u>Fig. 5</u>	-	1.5	1.7	V
		I _F = 10 A; T _j = 150 °C; <u>Fig. 5</u>	-	1.68	2	V
		I _F = 10 A; T _j = 175 °C; <u>Fig. 5</u>	-	1.75	2.1	V
I _R	reverse current	V _R = 650 V; T _j = 25 °C; <u>Fig. 6</u>	-	-	60	μA
		V _R = 650 V; T _j = 175 °C; <u>Fig. 6</u>	-	-	240	μA
Dynamic	characteristics					
Q _r	recovered charge	$I_{F} = 10 \text{ A}; V_{R} = 400 \text{ V}; \text{ d}I_{F}/\text{d}t = 500 \text{ A}/\mu\text{s}; T_{j} = 25 \text{ °C}; Fig. 7$	-	16	-	nC
C _d	diode capacitance	f = 1 MHz; V _R = 1 V; T _j = 25 °C	-	328	-	pF
		f = 1 MHz; V _R = 300 V; T _j = 25 °C	-	38	-	pF
		f = 1 MHz; V _R = 600 V; T _j = 25 °C	-	34	-	pF
E _{as}	non-repetitive avalanche energy	I _R = 5.5 A; L = 5 mH; T _{j(init)} = 25 °C	75	-	-	mJ



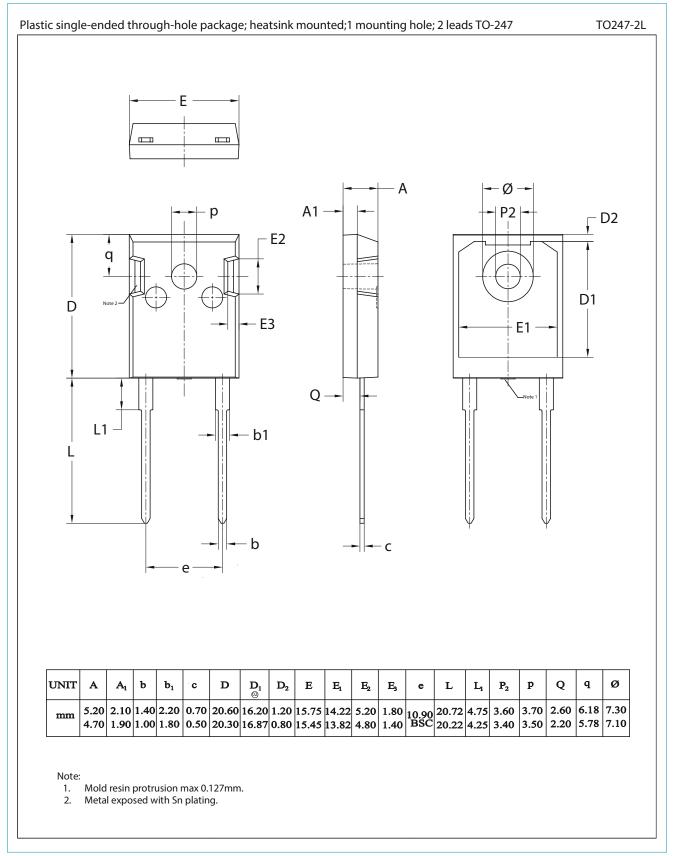




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11. Package outline



WNSC10650W

Silicon Carbide Diode

12. Legal information

Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

Please consult the most recently issued document before initiating or [1] completing a design.

- The term 'short data sheet' is explained in section "Definitions". [2]
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